

Notice of References Cited	Application/Control No. 10/623,783	Applicant(s)/Patent Under Reexamination OMAN ET AL.	
	Examiner Michael V. Datskovskiy	Art Unit 2835	Page 1 of 1

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*		Document Number Country Code-Number-Kind Code	Date MM-YYYY	Name	Classification
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	B	US-4,908,695	03-1990	Morihara et al.	257/719
	C	US-6,046,498	04-2000	Yoshikawa, Minoru	257/706
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	N	SU 1798945 A1	02-1993	Soviet Union	Abramov et al	H01L 023/34
	O	JP362109347A	05-1987	Japan	Tajima	H01L 023/46
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NON-PATENT DOCUMENTS

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	U	The Article "Spherical Cooling Device" IBM Technical Disclosure Bulletin, July 1991, Volume 34, Issue 2, Pages 1-3.
	V	The Article "Swivel Piston Conduction Module" IBM Technical Disclosure Bulletin, December 1977, Volume 20, Issue 7, Pages 2707-2708.
	W	The Article "TCM With Short Thermal Path Through Piston to Wide Contact Area Between header and Piston" IBM Technical Disclosure Bulletin, July 1985, Volume 28, Issue 2, Pages 766-767.
	X	The Article "Articulated Thermal Conductor for Semiconductor Packages" IBM Technical Disclosure Bulletin, January 1978, Volume 20, Issue 8, Pages 3131-3132.

*A copy of this reference is not being furnished with this Office action. (See MPEP § 707.05(a).)
Dates in MM-YYYY format are publication dates. Classifications may be US or foreign.